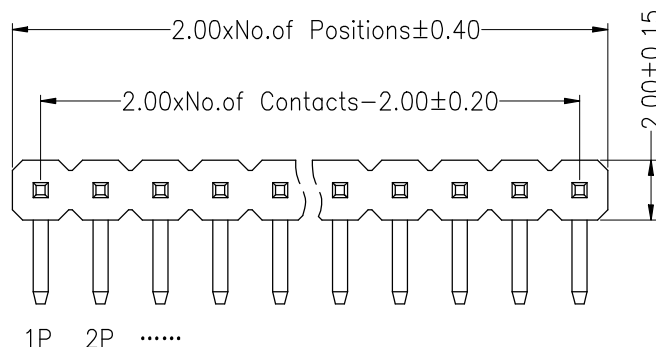




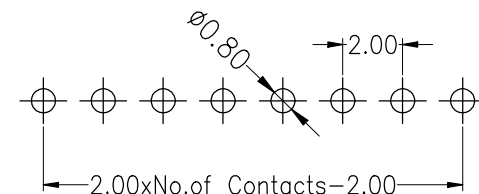
SPECIFICATIONS

Rated Current:2.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Soldering temperature:260℃±5° 5S

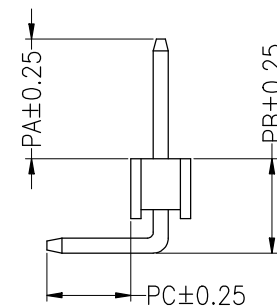
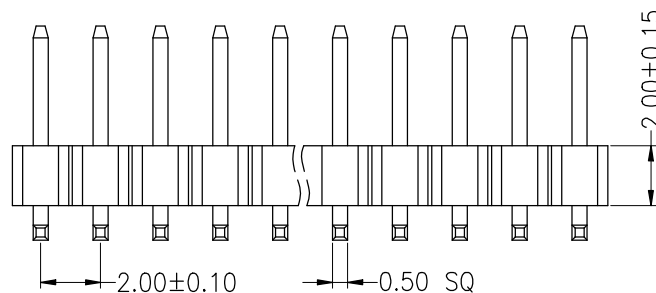


Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



Ordering Information

1320 11 XX X N XX R XXX X XX
No.of Pins 01~40P
Insulator Material Option
A=BK-PBT
C=BK-PA6T
E=BK-PA9T
F=BK-LCP
Contact Plating
G0:Gold Flash
G1:1u" Gold
G2:1.5u" Gold
G3:2u" Gold
G4:3u" Gold
G5:5u" Gold
G6:10u" Gold
G7:15u" Gold
G8:30u" Gold
S0:Gold Flash/Tin
SN:Tin
Pin Length
Packing
0=PE Bag
A=Tray
code stream
01~99



Dimension antitheses list

ITEM	PA	PB	PC
Standard	4.00	3.15	2.80

JILN® 深圳锦凌电子股份有限公司
SHENZHEN JINLING ELECTRONICS CO.,LTD

Tel: 86-755-27483253 Fax: 86-755-2997-5588

PART NO.	132011XXXNXXRXXXXXX
TITLE:	2.0PH H2.0mm 1xNpin 90°

				OPERATION	DRAW	YiYuSheng	12.04.18	SCALE	FIT
				X.X ±0.30				UNIT	mm
				X.XX ±0.20	CHECK			SIZE	A4
A0	2012.04.18	NEW DRAWING		X.XXX ±0.10				SHEET	1/1
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	Angle ±3°	APPROVE			PROJ.	Φ
				DIM TOL					